

Nell High Power Products

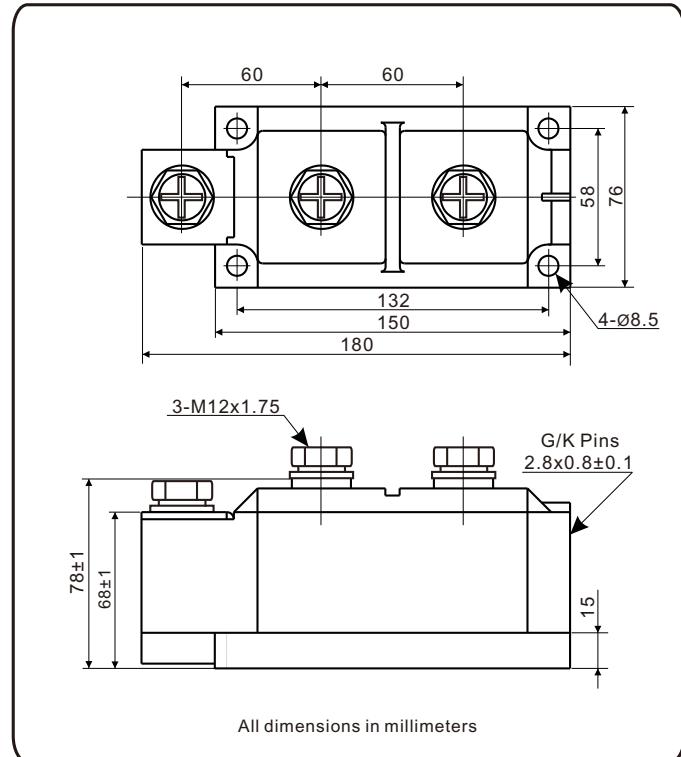
Thyristor/Diode and Thyristor/Thyristor, 800A (SUPER MAGN-A-PAK Power Modules)



SUPER MAGN-A-PAK(1)

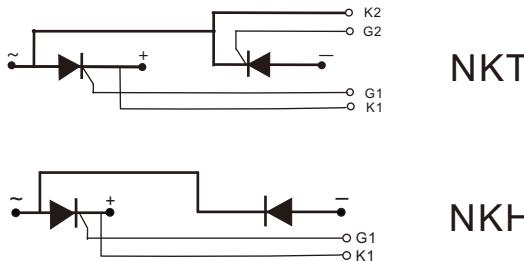
FEATURES

- High voltage
- Electrically isolated by DBC ceramic (Al_2O_3)
- 3500 V_{RMS} isolating voltage
- Industrial standard package
- High surge capability
- Modules uses high voltage power thyristor/diodes in two basic configurations
- Simple mounting
- UL approved file E320098 
- Compliant to RoHS
- Designed and qualified for multiple level



APPLICATIONS

- DC motor control and drives
- Battery charges
- Welders
- Power converters
- Lighting control
- Heat and temperature control
- Ups



PRODUCT SUMMARY	
I _{T(AV)}	800 A

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUE	UNITS
I _{T(AV)}	85 °C	800	A
I _{T(RMS)}	85 °C	1256	
I _{TSM}	50 Hz	24000	A
	60 Hz	25130	
I ² t	50 Hz	2880	kA ² s
	60 Hz	2621	
I ² √t		28800	kA ² √s
V _{DRM} / V _{RRM}	Range	400 to 1600	V
T _J	Range	-40 to 125	°C

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE	V_{RRM}/V_{DRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V_{RSM}/V_{DSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM}/I_{DRM} AT 125 °C mA
NKT800 NKH800	04	400	500	50
	08	800	900	
	10	1000	1100	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

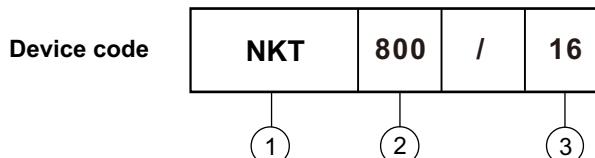
FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average on-state current at case temperature	$I_T(AV)$	180° conduction, half sine wave ,50Hz		800	A	
				85	°C	
Maximum RMS on-state current	$I_T(RMS)$	180° conduction, half sine wave ,50Hz , $T_C = 85^\circ C$		1256	A	
Maximum peak, one-cycle, on-state non-repetitive surge current	I_{TSM}	$t = 10 \text{ ms}$	No voltage reapplied	24000		
		$t = 8.3 \text{ ms}$		25130		
	I^2t	$t = 10 \text{ ms}$	Sine half wave, initial $T_J = T_J$ maximum	2880	kA^2s	
		$t = 8.3 \text{ ms}$		2621		
		$t = 10 \text{ ms}$		2016		
		$t = 8.3 \text{ ms}$		1835		
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1 \text{ ms to } 10 \text{ ms}$, no voltage reapplied		28800	$\text{kA}^2\sqrt{\text{s}}$	
Maximum on-state voltage drop	V_{TM}	$I_{TM} = 2400\text{A}$, $T_J = 25^\circ C$, 180° conduction		2.0	V	
Maximum forward voltage drop	V_{FM}	$I_{FM} = 2400\text{A}$, $T_J = 25^\circ C$, 180° conduction		1.7		
Maximum holding current	I_H	Anode supply = 12 V initial $I_T = 30 \text{ A}$, $T_J = 25^\circ C$		300	mA	
Maximum latching current	I_L	Anode supply = 12 V resistive load = 1 Ω Gate pulse: 10 V, 100 μs , $T_J = 25^\circ C$		500		

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Typical delay time	t_d	$T_J = 25^\circ C$, gate current = 1A, $dI_g/dt = 1 \text{ A}/\mu\text{s}$	$V_d = 0.67 V_{DRM}$	2.0	μs
Typical rise time	t_r			4.0	
Typical turn-off time	t_q	$I_{TM} = 750\text{A}$, $dI/dt = -60 \text{ A}/\mu\text{s}$, $T_J = T_J$ maximum $V_R = 50\text{V}$, $dV/dt = 20 \text{ V}/\text{dt}$, gate 0V, 100 Ω		200	

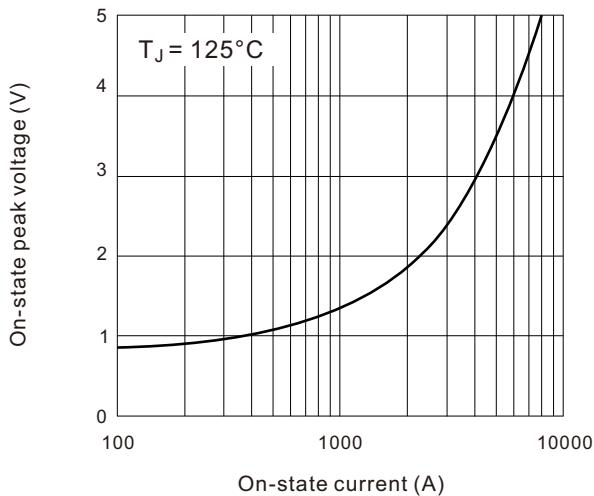
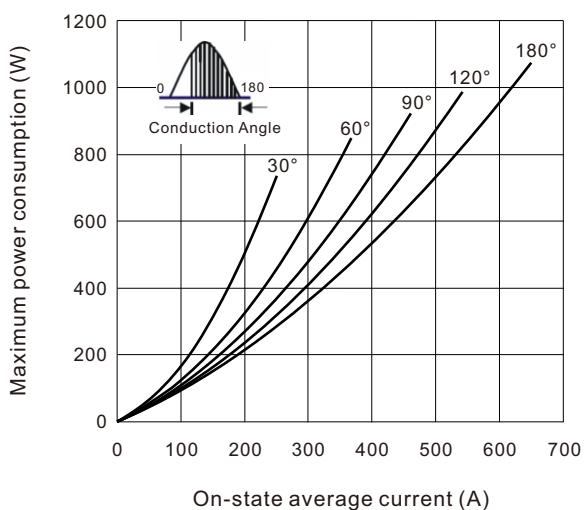
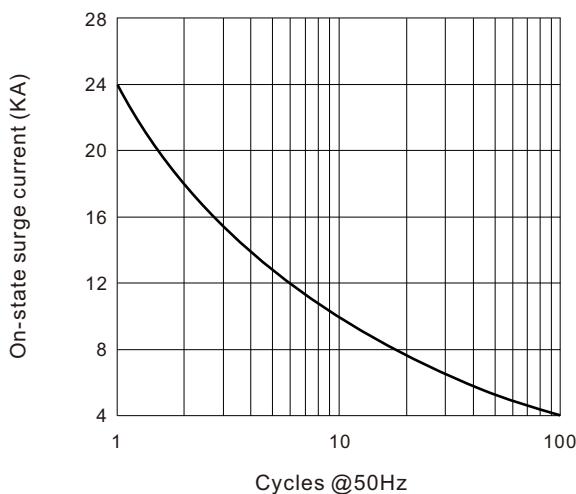
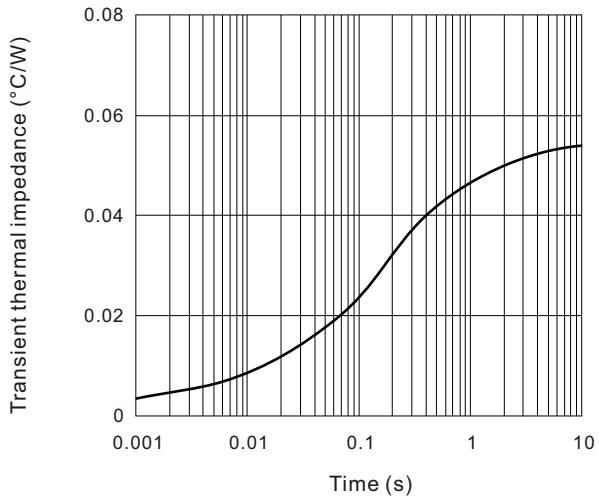
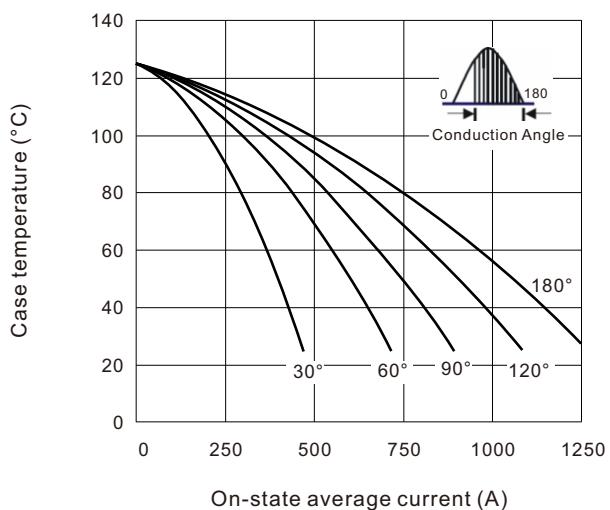
BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum peak reverse and off-state leakage current	$I_{RRM}\cdot I_{DRM}$	$T_J = 125^\circ C$		50	mA
RMS isolation Voltage	V_{ISO}	50 Hz, circuit to base, all terminals shorted, 25°C, 1s		3500	V
Critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, linear to $V_D = 80\% V_{DRM}$		1000	$\text{V}/\mu\text{s}$

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum peak gate power	P _{GM}	$t_p \leq 5 \text{ ms}$, T _J = T _J maximum		10	W
Maximum average gate power	P _{G(AV)}	f = 50 Hz, T _J = T _J maximum		2	
Maximum peak gate current	I _{GM}	$t_p \leq 5 \text{ ms}$, T _J = T _J maximum		3	A
Maximum peak positive gate voltage	+V _{GM}			20	
Maximum peak negative gate voltage	- V _{GM}			5.0	V
Maximum required DC gate voltage to trigger	V _{GT}			2	
Maximum required DC gate current to trigger	I _{GT}	T _J = 25 °C	Anode supply = 12 V, resistive load; R _a = 1Ω	200	mA
Maximum gate voltage that will not trigger	V _{GD}	T _J = T _J maximum, 67% V _{DRM} applied		0.25	V
Maximum gate current that will not trigger	I _{GD}			10	
Maximum rate of rise of turned-on current	dI/dt	T _J = T _J maximum, I _{TM} = 400A rated V _{DRM} applied		1000	A/μs

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
junction operating and storage temperature range	T _J , T _{stg}			- 40 to 125	°C
Maximum thermal resistance, junction to case per junction	R _{thJC}	DC operation		0.054	°C/W
Typical thermal resistance, case to heatsink per module	R _{thCS}	Mounting surface, smooth , flat and greased		0.008	
Mounting torque ± 10 %	SMAP to heatsink , M8 busbar to SMAP , M12	A mounting compound is recommended and the torque should be rechecked after a period of about 3 hours to allow for the spread of the compound.		6 to 8 13 to 16	N·m
Approximate weight				3500 123	
Case style				SUPER MAGN-A-PAK(1)	

ORDERING INFORMATION TABLE


- [1] - Module type: NKT for (Thyristor + Thyristor) module
NKH for (Thyristor + Diode) module
- [2] - Current rating: I_{T(AV)}
- [3] - Voltage code x 100 = V_{RRM}

Nell High Power Products
Fig.1 On-state current vs. voltage characteristics

Fig.3 Power consumption vs. average current

Fig.5 On-state surge current vs cycles

Fig.2 Transient thermal impedance (junction-case)

Fig.4 Case temperature vs. on-state average current

Fig.6 I^2t characteristics
